



10,1" plně odolný tablet se systémem Windows 11 Pro

TOUGHBOOK G2 mk3 Standard

TOUGHBOOK G2 je nová generace odolného zařízení pro mobilní pracovníky. Nabízí všechny výhody nejnovějších technologií a zároveň zachovává důležitý přístup ke starším systémům. To vše zabalené do flexibilnějšího, bezpečnějšího a v konečném důsledku ještě použitelnějšího zařízení.

Key Features

Procesor Intel® Core™ Ultra5 135U (s technologií Intel vPro)

Systém Windows 11 Pro

10,1" barevný LCD displej s aktivní matricí (TFT) 1920 x 1200 (WUXGA) s kapacitním dotykovým displejem s možností pozorování na slunci v rukavicích (až 1 000 cd/m²), IP55 Digitizér

Odolnost proti vodě a prachu IP65****, testováno podle MIL-STD 810H****

Dlouhá výdrž baterie až 15 hodin (Mobile Mark™ 25) s rozšířenou baterií

TOUGHBOOK





TOUGHBOOK G2 mk3 Standard

EVOLVED TO ADAPT

An evolution of the best-selling Panasonic Toughbook G1 tablet and 20 detachable, this latest tablet is powered by the 12th Generation Intel® Core™ Ultra5 135U processor, delivering incredible performance, and is shipping with Windows 11 Pro. It also has a rich set of business interfaces with additional customisable options to meet a worker's needs. With its long battery life and outdoor viewing, glove-enabled

touchscreen, it's a versatile yet tough technology companion for mobile workers.

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<https://eu.connect.panasonic.com/cz/cs/toughbook/toughbook-g2-series/toughbook-g2-mk3-standard>

Model	FZ-G2mk3 Standard, 16GB RAM, 512GB SSD, standard battery pack, IP55 digitiser pen
Operating System	Windows 11 Pro
Mobile Computing Platform	Intel® Core™ Ultra5 processor 135U (with Intel vPro® Technology)
Graphic Chip	Intel® Graphics (Built-in CPU)
RAM	16GB (max. 32GB) DDR5x
Storage	512GB OPAL NVMe SSD (up to 2TB optional)
LCD	10.1" Active Matrix (TFT) colour LCD 1920 x 1200 (WUXGA) LCD with sunlight-viewable glove enabled capacitive touchscreen (up to 1.000cd/m²), IP55 Digitiser
Wireless	Mobile Broadband*: 4G or 5G with SIM/eSIM support Wireless LAN: Intel® Wi-Fi6E AX211 GPS*: U-Blox NEO-M9N Series (not compatible to 5G mode) LAN: IEEE 802.3 10Base-T / IEEE 802.3u 100BASE-TX / IEEE 802.3ab 1000BASE-TBluetooth™: 5.3 Class 1 Mobile
Interfaces	USB 3.2 Gen 1 Type A: x1 Thunderbolt 4: x1 LAN: x1 Dual Antenna Connector: x1
Rear expansion area	Smart Card Reader, HF-RFID (NFC) Reader, Fingerprint Reader***
Top Expansion Area	Serial, 2D Barcode Reader, 2nd USB 2.0, 2nd LAN, Thermal by FLIR, Micro-SD**
Front Camera	2 MP with IR / privacy shutter (Windows Hello compliant)
Rear Camera	13mpixel with autofocus and LED flash
Sound	Intel® High Definition Audio subsystem support, Stereo speaker
Security	TPM (TCG V2.0 compliant), Integrated hardware security lock slot, Windows Hello compliant Webcam
Keyboard & Input (Keyboard)	x1 *
Pointing device: Touchscreen (Touch panel)	Touchpad
Dimensions: Main Unit + Keyboard (WxHxD)	287 mm x 235 mm x 52.7 mm / 11.3" x 9.3" x 2.1" (without protruding parts)
Dimensions: Main Unit (WxHxD)	279mm x 188mm x 23.5 mm / 11.0" x 7.4" x1.0" (without protruding parts)
Weight: Main Unit	Approx. 1.19kg / 2.64lb
Battery Life	Standard: Approx 11 hours (Mobile Mark™ 25) Extended: Approx 15 hours (Mobile Mark™ 25)*****
Power Supply: AC Adaptor	Input: 100 V - 240 V AC, 50 Hz/ 60 Hz, Output: 15.6 V DC, 7.05 A
Power Supply: Battery	Standard: Li-ion 11.4V, 4360mAh (50Whr), Extended: Li-ion 10.8V, 6300mAh (68Whr)
Power Supply: Hot Swap	Standby function, ACPI BIOS, Hot swap optional
Drop resistance	MIL-STD 810H, 180cm ****
Dust resistance	IEC529 (JIS C0920) IP6x ****
Water resistance	IEC529 (JIS C0920) IPx5 ****
Operating temperature	MIL-STD 810H, -29 °C to 63 °C ****
Included in the box	Power Supply, Power Cord, Display cleaning cloth and User Manual
Integrated options	Port Replicator: x1
Footnote Description	* Optional ** One option exclusive possible in Top Expansion Bay Area, End User replaceable *** One option exclusive possible in Rear Expansion Bay Area, End User replaceable **** Tested by an independent third party lab following MIL-STD-810H and IEC 60529, Sections 13.4, 13.6.2, 14.2.5 and 14.3

FZ-G2 mk2: September 2024

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